

32ND INTERNATIONAL CONFERENCE ON VLSI DESIGN AND 18TH INTERNATIONAL CONFERENCE ON EMBEDDED SYSTEMS

January 05 - 09, 2019 | New Delhi, India

INVITATION TO SPONSOR ONE OF THE MOST LEADING GLOBAL CONFERENCES FOR **VLSI DESIGN & EMBEDDED SYSTEMS**

Dear Visionary,

The global ecosystem is getting bigger and bigger day by day but the distances are getting closer & closer. Whether it's collaborating closely with different stakeholders from different continents with a focused goal of achieving something new & exciting, expanding & extending newer boundaries, enlarging technical capabilities, sprouting innovations, nurturing talents & discoveries, etc. This challenging & exciting transition is bringing in more opportunities to all stakeholders, technologists, industry leaders, entrepreneurs, policy makers and academicians. The most beguiling aspect for any participant in the semiconductor and embedded domain is, to make things happen and in a way that is progressive, radical, revolutionary, gratifying, vital, expedient and novel.

The 32nd International Conference on VLSI Design & The 18th International Conference on Embedded Systems (VLSID2019), with the theme Autonomous Intelligence for a Secure, Safer, & Smarter World, are being held jointly at New Delhi, India, during January 5-9, 2019. With its global footprints VLSID is recognized as a 'Sister Conference' of Design Automation Conference. Over a span of five-days, the summit will feed brains and nurture minds with stateof-the-art exhibitors, presentations, panel discussions, innovation forums, and tutorials by established technologists.

VLSI conference is unique, bringing together all the stakeholders of the ecosystem - researchers, industry, academicians and regulators. VLSID2019 will act as a unique catalyst to accelerate the involvement of companies in the area of VLSI design and embedded systems, with an emphasis on cutting edge technologies - exchanging ideas, expounding on research areas, detailing on the business opportunities, companies introducing their offerings. VLSID2019 attendees shall include, designers, engineers, technology visionaries, corporate leaders, academicians from across the globe, with facilities to conduct business discussions. The organizing committee is taking all the steps to ensure good participation, both in terms of quantity and quality, through a strong technical program including:

- Visionary Keynote speeches
- Technical paper tracks
- **Government Expert Panels**
- Industry panels
- **Exhibits**
- **Tutorials**
- **Special Sessions**

- **Student Program**
- **User Tracks**
- Design contests/Hackathon
- PhD forum
- Fellowship Program
- Academia Expert
- **Posters**

As a visionary in the Academic sector, one of the most important challenges for you today is to establish the superior leadership in education and to help drive grow the latest technologies, Industry partnerships & jobs to your Institution. VLSID-2019 is the appropriate forum that provides perfect opportunities for you to:

- Own & Drive your educational institute brand image in this 5-day International IEEE Conference
- Ensure immense value to gain potential partnership, jobs & Global leaders to your Institution.
- Engage with senior professors of reputed universities across the globe for research collaboration
- Opportunity to establish your institutional brand in India & Internationally
- Showcase institution's strengths to the industry to attract partnerships
- Collaboration opportunities with government sector bodies Good forum to attract Global companies from different regions globally
- Gain traction with entrepreneurs, MSMEs so that they can set their operations in your ecosystem
- Connecting with key industry players who can contribute to realizing your larger vision

Please find below details of the sponsorship opportunities for your favorable consideration. The sponsorship table (Please note that the sponsorship package rates are slated to rise from July 15, 2018), enrollment form and details of various sponsorships are attached herewith. As you will notice, the packages are formulated to ensure the best possible Return On Investment (RoI) for your Institution. Your early decision to participate will enable us to serve you better, with even higher Rol, and ensures that the conference will exceed your expectations. We will be glad to get an opportunity to provide more details and close with you at the very earliest.

Yours Truly, Sponsorship Chair VLSID2019









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EDUCATION PARTNER SPONSORSHIP (4 Sponsors only) - INR 750000 + GST

- One keynote slot in the Student conference program on Day 1
- Exclusive partner of the Industry forum
- CEO & CXO Networking dinner Appropriate slot
- Appropriate slot in the Banquet dinner attended by key Industry leaders and stakeholders
- Appropriately sized logo on the side panels of the backdrop on stage(s), along with other applicable logos
- Logo on the conference item (Choice from the list available for Silicon sponsors on a FCFS basis (FIFO)) up to the allotted amount.
- Coverage in print media as per conference's publicity plan that gets to be in place
- Advertisement in the conference Souveneir
- 10 complimentary passes to the conference
- 5 complimentary passes to the Banquet ceremony
- One exhibit stall of (6x6)m for interactions.
- Your sponsored attendees Fellows: Teachers, Doctoral candidates, Students



Institutions confirming the sponsorships along with payments by Sept 24, 2018 will be eligible for a 10% discount of the sponsorship value

Sponsorship Team Contacts

General Chair Preet Yadav preet.yadav@gmail.com

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1.	NAME AND ADDRESS OF THE ORGANISATION		
2.	COMPANY CONTACT PERSON	20 E	
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	PHONE & MOBILE		
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